

## **Product Change Notification / GBNG-15STBN649**

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21-Mar-2023

# **Product Category:**

8-bit Microcontrollers

# **PCN Type:**

Manufacturing Change

# **Notification Subject:**

CCB 6193 Final Notice: Qualification of MTAI as an additional assembly site for selected ATTINY13A device family available in 8L SOIC (.150in) package with MSL 1 classification.

### **Affected CPNs:**

GBNG-15STBN649\_Affected\_CPN\_03212023.pdf GBNG-15STBN649\_Affected\_CPN\_03212023.csv

#### **Notification Text:**

**PCN Status:**Final Notification

**PCN Type:**Manufacturing Change

**Microchip Parts Affected:**Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

**Description of Change:**Qualification of MTAI as an additional assembly site for selected ATTINY13A device family available in 8L SOIC (.150in) package with MSL 1 classification.

### **Pre and Post Change Summary:**

	Pre Change	Post Change				
Assembly Site	Amkor Technology	Amkor Technology	Microchip			

	Philippine (P1/P2), INC. (ANAP)	Philippine (P1/P2), INC. (ANAP)	Technology Thailand (HQ) (MTAI)		
Wire Material	Au Au		Au		
Die Attach Material	8290	8390A			
Molding Compound Material	G600	G600	G600		
Lead-Frame Material	C194	C194	C194		
Lead-Frame Paddle Size	90 x 130 mils	90 x 130 mils	90 x 90 mils		
DAP Surface Prep	NiPdAu NiPdAu		Bare Cu		
Lead Plating	NiPdAu	NiPdAu	Matte Tin		
Lead-lock	No	No	Yes		
Lead-Frame Design	See attached Pre and Post change comparison.				
Moisture Sensitivity Level (MSL)	MSL 2	MSL 2	MSL 1		

# Impacts to Data Sheet:None

## Change ImpactNone

**Reason for Change:**To improve on-time delivery performance by qualifying MTAI as an additional assembly site.

# **Change Implementation Status:**In Progress

Estimated First Ship Date: April 2, 2023 (date code: 2314)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

## **Time Table Summary:**

	March 2023				April 2023					
Workweek	0 9	1 0	1 1	1 2	1 3	1 4	1 5	1 6	1 7	1 8
Final PCN Issue Date				Х						
Qual Report Availability				Х						
Estimated Implementation Date						Х				

Method to Identify Change: Traceability code

**Qualification Report:**Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

**Revision History:**March 21, 2023: Issued final notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

#### Attachments:

PCN\_GBNG-15STBN649\_Pre\_and\_Post\_Change\_Summary.pdf PCN\_GBNG-15STBN649\_QUAL REPORT.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

#### **Terms and Conditions:**

If you wish to <u>receive Microchip PCNs via email</u> please register for our PCN email service at our <u>PCN</u> home page select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the <u>PCN FAQ</u> section.

If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

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Affected Catalog Part Numbers (CPN)

ATTINY13A-SSH ATTINY13A-SS7 ATTINY13A-SSHR ATTINY13A-SSHR

Date: Monday, March 20, 2023